1-120521-1 ACTIVE

Free Height

TE Internal #: 1-120521-1

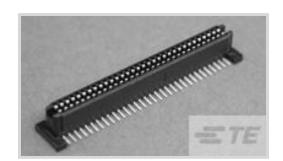
PCB Mount Receptacle, Vertical, Board-to-Board, 64 Position, 1 mm [.039 in] Centerline, Gold, Surface Mount, Signal, Black, Tape &

Reel, Free Height

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Free Height Receptacle Conn: Board-Board, Vertical, 64, 1mm



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 64

Centerline (Pitch): 1 mm [.039 in]

All Free Height Receptacle Conn: Board-Board, Vertical, 64, 1mm (57)

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Columns	32

Number of Columns	32
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	64
Board-to-Board Configuration	Parallel

Electrical Characteristics

Insulation Resistance	2 ΜΩ
Operating Voltage	250 VAC

Signal Characteristics

Differential Signaling	Yes
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Body Features



PCB Contact Termination Area Plating Material Thickness 3.81 µm(150 µin) Contact Layout Inline Mating Tab Width		
PCB Contact Termination Area Plating Material Thickness	Primary Product Color	Black
Contact Layout Inline Mating Tab Width As am [024 in] Mating Tab Thickness 2 mm [028 in] Contact Underplating Material Thickness 1.27 µm [50 µin] PCB Contact Termination Area Plating Material Finish Matte Contact Shape & Form Single Bearm PCB Contact Termination Area Plating Material PCB Contact Termination Area Plating Material PCB Contact Termination Area Plating Material Contact Base Material Contact Mating Area Plating Material Thickness 7.6 µm [29-9212 µin] Contact Type Socket Contact Current Rating (Max) 1.A Fermination Features Rectangular Termination Post & Tail Width 3 mm [001 in] Rectangular Termination Post & Tail Width 3 mm [001 in] Termination Method to PCB Sunface Mount Mechanical Attachment Mechanical Attachment PCB Mount Alignment Type None Mating Retention Pye None Mating Alignment Mating Alignment Type None Mating Alignment Type None PCB Mount Retention Type None Mating Alignment Without Mating Alignment Type None PCB Mount Alignment Mating Alignment Muthout PCB Mount Alignment Mating Alignment Mating Alignment Muthout PCB Mount Alignment Muthout Mating Alignment Muthout Mating Alignment Muthout Mating Alignment Muthout Mating Alignment Muthout	Contact Features	
Mating Tab Width	PCB Contact Termination Area Plating Material Thickness	3.81 μm[150 μin]
Mating Tab Thickness 1.27 µm[50 µin] Contact Underplating Material Thickness 1.27 µm[50 µin] PCB Contact Termination Area Plating Material Tinish Matte Contact Shape & Form Single Beam PCB Contact Termination Area Plating Material Contact Base Material Contact Base Material Contact Base Material Contact Mating Area Plating Material Contact Mating Area Plating Material Contact Mating Area Plating Material Contact Type Socket Contact Type Socket Contact Current Rating (Max) 1A Fermination Features Rectangular Termination Post & Tail Thickness 2.2 mm[.008 in] Rectangular Termination Post & Tail Width 3.mm[.011 in] Termination Method to PCB Surface Mount Method to PCB Without Alignment Type Locating Posts Mating Retention Without PCB Mount Alignment Type None Mating Alignment Type None Mating Alignment Type None PCB Mount Retention Type Without Mating Alignment Type None PCB Mount Retention Type None PCB Mount Alignment Type None PCB Mount Alignment Type None PCB Mount Alignment Mithout Mating Alignment Mating Alignme	Contact Layout	Inline
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PCB Contact Termination Area Plating Material Finish Single Beam PCB Contact Shape & Form Single Beam PCB Contact Termination Area Plating Material Tin-Lead Contact Base Material Phosphor Pronze Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Thickness 7.6 μm(29.9212 μin) Contact Type Socket Contact Current Rating (Max) 1 A Fermination Features Rectangular Termination Post & Tail Thickness 2.2 mm(.008 in) Rectangular Termination Post & Tail Width 3.3 mm(.011 in) Termination Method to PCB Surface Mount Mechanical Attachment PCB Mount Alignment Type Locating Posts Mating Retention Without Mating Alignment Type None Mating Alignment Type None PCB Mount Retention Without Mating Alignment Type None PCB Mount Retention Without Mating Alignment Type None PCB Mount Retention Without PCB Mount Retention Type None PCB Mount Alignment Type None PCB Mount Retention Type None	Mating Tab Thickness	.2 mm[.008 in]
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Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Thickness 7.6 µm[29.9212 µin] Contact Type Socket Contact Current Rating (Max) 1 A Fermination Features Rectangular Termination Post & Tail Thickness 2.2 mm[.008 in] Rectangular Termination Post & Tail Width 3.3 mm[.011 in] Termination Method to PCB Surface Mount Mechanical Attachment PCB Mount Alignment Type Locating Posts Mating Retention Without PCB Mount Retention Type None Mating Alignment Type None PCB Mount Retention Mating Alignment Type Without Mating Alignment Type None PCB Mount Retention PCB Mount Retention PCB Mount Retention Top Centerline (Pitch) 1 mm[.039 in] Housing Material	PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Thickness	Contact Base Material	Phosphor Bronze
Contact Type Socket Contact Current Rating (Max) 1A Fermination Features Rectangular Termination Post & Tail Thickness .2 mm[.008 in] Rectangular Termination Post & Tail Width .3 mm[.011 in] Termination Method to PCB Surface Mount Mechanical Attachment PCB Mount Alignment Type Locating Posts Mating Retention Type None Mating Alignment Mating Alignment Type None PCB Mount Retention Type None PCB Mount Retention Mating Alignment Type None Mating Alignment Type None Centerline (Pitch) 1 mm[.039 in] Housing Material Matterline Matterline Matterline Matterline Matterline (Pitch) 1 mm[.039 in]	Contact Mating Area Plating Material	Gold
Contact Current Rating (Max) Fermination Features Rectangular Termination Post & Tail Thickness	Contact Mating Area Plating Material Thickness	.76 μm[29.9212 μin]
Fermination Features Rectangular Termination Post & Tail Thickness .2 mm[.008 in] Rectangular Termination Post & Tail Width .3 mm[.011 in] Termination Method to PCB .5 Surface Mount Mechanical Attachment PCB Mount Alignment Type .1 Locating Posts Mating Retention .7 Without Mating Alignment .7 Without Mating Alignment .7 Without Mating Alignment .7 Without Mount Retention .7 Without Mating Alignment .7 Without Mating Alignment .7 Without Mount Retention .7 Without Mating Alignment .7 Without Mount Retention .7 Without Mount Retention .7 Without Mount Retention .7 Without PCB Mount Alignment .7 Without Mount Retention .7 Without Mount Retention .7 Without Housing Features Mating Entry Location .7 Top Centerline (Pitch) .1 mm[.039 in] Housing Material .7 Matter	Contact Type	Socket
Rectangular Termination Post & Tail Thickness 2 mm[.008 in] Rectangular Termination Post & Tail Width 3 mm[.011 in] Termination Method to PCB Surface Mount Mechanical Attachment PCB Mount Alignment Type Location Post Without Mating Retention Without Mating Alignment Type None PCB Mount Retention Type None Mating Alignment Type None PCB Mount Retention Without Mone PCB Mount Retention Without Mating Alignment Type None Centerline (Pitch) 1 mm[.039 in] Housing Material	Contact Current Rating (Max)	1 A
Rectangular Termination Post & Tail Width .3 mm[.011 in] Termination Method to PCB Surface Mount Mechanical Attachment PCB Mount Alignment Type Locating Posts Mating Retention Without PCB Mount Retention Type None Mating Alignment Type None PCB Mount Retention Without Mating Alignment Type None PCB Mount Retention Without Mating Alignment Type None PCB Mount Retention Without Mating Features Mating Entry Location Top Centerline (Pitch) 1 mm[.039 in] Housing Material	Termination Features	
Termination Method to PCB Mechanical Attachment PCB Mount Alignment Type Mating Retention PCB Mount Retention Type Mating Alignment Mating Alignment Type None PCB Mount Retention More PCB Mount Retention More PCB Mount Retention More PCB Mount Retention Top Centerline (Pitch) Housing Material Mating Material Mating Mount Method to PCB Surface Mount Without Without Without Without Top Mating Entry Location Top Matte	Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Mechanical Attachment PCB Mount Alignment Type Locating Posts Mating Retention Without PCB Mount Retention Type None Mating Alignment Mating Alignment Type None PCB Mount Retention Without PCB Mount Retention Without PCB Mount Alignment Without PCB Mount Alignment Type Top Centerline (Pitch) Housing Material Matte	Rectangular Termination Post & Tail Width	.3 mm[.011 in]
PCB Mount Alignment Type Mating Retention Without PCB Mount Retention Type None Mating Alignment Mating Alignment Type None PCB Mount Retention Without Mount Retention Without PCB Mount Retention Without PCB Mount Alignment With Housing Features Mating Entry Location Centerline (Pitch) Housing Material Matte	Termination Method to PCB	Surface Mount
Mating Retention Without PCB Mount Retention Type None Mating Alignment Without Mating Alignment Type None PCB Mount Retention Without PCB Mount Alignment With Housing Features Mating Entry Location Top Centerline (Pitch) 1 mm[.039 in] Housing Material Matte	Mechanical Attachment	
PCB Mount Retention Type Mating Alignment Mating Alignment Type None PCB Mount Retention PCB Mount Retention Without Without With Housing Features Mating Entry Location Centerline (Pitch) Housing Material Matte	PCB Mount Alignment Type	Locating Posts
Mating Alignment Type None PCB Mount Retention PCB Mount Alignment Without Housing Features Mating Entry Location Centerline (Pitch) Housing Material Matte	Mating Retention	Without
Mating Alignment Type PCB Mount Retention Without PCB Mount Alignment Housing Features Mating Entry Location Centerline (Pitch) Housing Material Matte	PCB Mount Retention Type	None
PCB Mount Retention Without PCB Mount Alignment With Housing Features Mating Entry Location Top Centerline (Pitch) 1 mm[.039 in] Housing Material Matte	Mating Alignment	Without
PCB Mount Alignment Housing Features Mating Entry Location Centerline (Pitch) Housing Material Matte	Mating Alignment Type	None
Housing Features Mating Entry Location Top Centerline (Pitch) 1 mm[.039 in] Housing Material Matte	PCB Mount Retention	Without
Mating Entry Location Top Centerline (Pitch) 1 mm[.039 in] Housing Material Matte	PCB Mount Alignment	With
Centerline (Pitch) Housing Material Matte	Housing Features	
Housing Material Matte	Mating Entry Location	Тор
	Centerline (Pitch)	1 mm[.039 in]
Dimensions	Housing Material	Matte
	Dimensions	



Connector Length	34.22 mm[1.347 in]
Connector Height	5.37 mm[.211 in]
Connector Width	3.81 mm[150 in]
Stack Height	8 mm, 9 mm, 10 mm[.394 in]
Usage Conditions	
Operating Temperature Range	-55 – 110 °C[-67 – 230 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Rating	Listed
Compatible With Agency/Standards Products	CSA, UL
Compatible With Approved Standards Products	CSA LR7189, UL E28476
Industry Standard	IEEE 1386
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	650

Tape & Reel

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

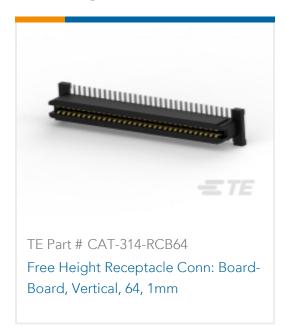
PCB Mount Receptacle, Vertical, Board-to-Board, 64 Position, 1 mm [.039 in] Centerline, Gold, Surface Mount, Signal, Black, Tape & Reel, Free Height



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | Free Height



Customers Also Bought









PCB Mount Receptacle, Vertical, Board-to-Board, 64 Position, 1 mm [.039 in] Centerline, Gold, Surface Mount, Signal, Black, Tape & Reel, Free Height











TE Part #CY7148-000 2524F0524-1L/9-9CS1553-L016

Documents

Product Drawings

1FHR,64,50A/P,S,N,S08,09,10

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-120521-1_K.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-120521-1_K.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-120521-1_K.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English